

28-lead PDIP

Top view

28 🗆 VCC

27 A A14

26 🗆 A13

25 🗆 A8

24 🗆 A9

23 🗆 A11

22 DE

19 🗆 07

16 🗆 04

15 🗆 03

□ CE

21 🗆 A10

20

VPP ☐ 1

A12 🗆 2

A7 ☐ 3

A6 ☐ 4

A5 □ 5

A4 ☐ 6

A3 □ 7

A2 ☐ 8

A1 ☐ 9

A0 ☐ 10

00 🗆 11

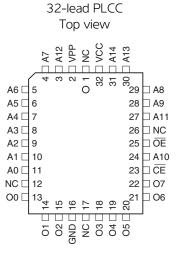
01 🗖 12

02 🗆 13

GND ☐ 14

### 2. Pin configurations

Pin name	Function
A0 - A14	Addresses
O0 - O7	Outputs
Œ	Chip enable
ŌĒ	Output enable
NC	No connect

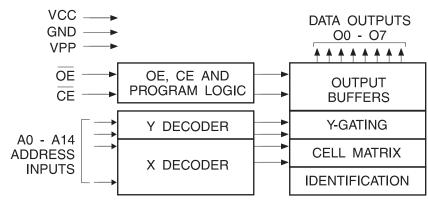


Note: PLCC package pins 1 and 17 are "don't connect"

## 3. System considerations

Switching between active and standby conditions via the chip enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device non-conformance. At a minimum, a  $0.1\mu\text{F}$ , high-frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the  $V_{CC}$  and ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a  $4.7\mu\text{F}$  bulk electrolytic capacitor should be utilized, again connected between the  $V_{CC}$  and ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

Figure 3-1. Block diagram



#### Absolute maximum ratings\* 4.

Temperature under bias55°C to +125°C
Storage temperature65°C to +150°C
Voltage on any pin with respect to ground2.0V to +7.0V <sup>(1)</sup>
Voltage on A9 with respect to ground2.0V to +14.0V <sup>(1)</sup>
V <sub>pp</sub> supply voltage with respect to ground2.0V to +14.0V <sup>(1)</sup>

\*NOTICE: Stresses beyond those listed under "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note:

1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20ns. Maximum output pin voltage is  $V_{CC}$  + 0.75V DC, which may overshoot to +7.0V for pulses of less than 20ns.

#### 5. DC and AC characteristics

Table 5-1. Operating Modes

Mode/Pin	Œ	ŌĒ	Ai	$V_{pp}$	Outputs
Read	V <sub>IL</sub>	V <sub>IL</sub>	Ai	V <sub>CC</sub>	D <sub>OUT</sub>
Output disable	V <sub>IL</sub>	V <sub>IH</sub>	X <sup>(1)</sup>	V <sub>CC</sub>	High Z
Standby	V <sub>IH</sub>	X <sup>(1)</sup>	X <sup>(1)</sup>	V <sub>CC</sub>	High Z
Rapid program <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IH</sub>	Ai	$V_{pp}$	D <sub>IN</sub>
PGM verify <sup>(2)</sup>	X <sup>(1)</sup>	V <sub>IL</sub>	Ai	$V_{pp}$	D <sub>OUT</sub>
Optional PGM verify <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IL</sub>	Ai	V <sub>CC</sub>	D <sub>OUT</sub>
PGM inhibit <sup>(2)</sup>	V <sub>IH</sub>	V <sub>IH</sub>	X <sup>(1)</sup>	$V_{pp}$	High Z
Product identification <sup>(4)</sup>	$V_{\rm L}$	$V_{\rm L}$	$A9 = V_{H}^{(3)}$ $A0 = V_{IH} \text{ or } V_{IL}$ $A1 - A14 = V_{IL}$	V <sub>CC</sub>	Identification code

Notes:

- 1. X can be  $V_{II}$  or  $V_{IH}$ .
- 2. Refer to programming characteristics.
- 3.  $V_H = 12.0 \pm 0.5 V$ .
- 4. Two identifier bytes may be selected. All Ai inputs are held low  $(V_{IL})$ , except A9, which is set to  $V_{H}$ , and A0, which is toggled low  $(V_{\parallel})$  to select the manufacturer's identification byte and high  $(V_{\parallel})$  to select the device code byte.

Table 5-2. DC and AC operating conditions for read operation

		Atmel A	T27C256R
		-45	-70
Operating temp. (case)	Ind.	-40°C − 85°C	-40°C - 85°C
	Auto.		-40°C − 125°C
V <sub>CC</sub> supply		5V ± 10%	5V ± 10%





Table 5-3. DC and operating characteristics for read operation

Symbol	Parameter	Condition		Min	Max	Units
	loos to look surrent	)/ O)/+o.)/	Ind.		±1	μΑ
I ILI	Input load current	$V_{IN} = OV \text{ to } V_{CC}$	Auto.		±5	μΑ
	O that the leaders are as a second	0)/+- )/	Ind.		±5	μΑ
I <sub>LO</sub>	Output leakage current	$V_{OUT} = 0V \text{ to } V_{CC}$	Auto.		±10	μΑ
I <sub>PP1</sub> (2)	V <sub>PP</sub> <sup>(1)</sup> read/standby current	$V_{PP} = V_{CC}$			10	μΑ
	)/ (1) -t	$I_{SB1}$ (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$			100	μΑ
I <sub>SB</sub>	V <sub>CC</sub> <sup>(1)</sup> standby current	$I_{SB2}$ (TTL), $\overline{CE}$ = 2.0 to $V_{CC}$ + 0.5V			1	mA
I <sub>CC</sub>	V <sub>CC</sub> active current	$f = 5MHz$ , $I_{OUT} = 0mA$ , $\overline{E}$	= V <sub>IL</sub>		20	mA
V <sub>IL</sub>	Input low voltage			-0.6	0.8	V
V <sub>IH</sub>	Input high voltage			2.0	V <sub>CC</sub> + 0.5	V
V <sub>OL</sub>	Output low voltage	I <sub>OL</sub> = 2.1mA			0.4	V
V <sub>OH</sub>	Output high voltage	$I_{OH} = -400\mu A$		2.4		V

Notes: 1.  $V_{CC}$  must be applied simultaneously with or before  $V_{pp}$ , and removed simultaneously with or after  $V_{pp}$ .

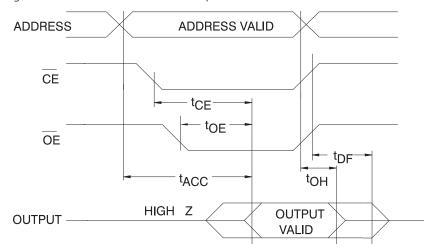
Table 5-4. AC characteristics for read operation

				Atmel AT27C256R			
			_	45	-70		
Symbol	Parameter	Condition	Min	Max	Min	Max	Units
t <sub>ACC</sub> <sup>(1)</sup>	Address to output delay	$\overline{CE} = \overline{OE} = V_{IL}$		45		70	ns
t <sub>CE</sub> <sup>(1)</sup>	CE to output delay	OE = V <sub>IL</sub>		45		70	ns
t <sub>OE</sub> <sup>(1)</sup>	OE to output delay	CE = V <sub>IL</sub>		20		30	ns
t <sub>DF</sub> <sup>(1)</sup>	OE or CE high to output float, whichever occurred first			20		25	ns
t <sub>OH</sub>	Output hold from address, $\overline{\text{CE}}$ or $\overline{\text{OE}}$ , whichever occurred first		7		7		ns

Note: 1. See AC waveforms for read operation.

<sup>2.</sup>  $V_{PP}$  may be connected directly to  $V_{CC}$ , except during programming. The supply current would then be the sum of  $I_{CC}$  and  $I_{PP}$ .

Figure 5-1. AC waveforms for read operation<sup>(1)</sup>

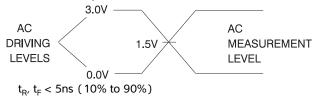


Notes:

- 1. Timing measurement reference level is 1.5V for -45 devices. Input AC drive levels are  $V_{IL} = 0.0V$  and  $V_{IH} = 3.0V$ . Timing measurement reference levels for all other speed grades are  $V_{OL} = 0.8V$  and  $V_{OH} = 2.0V$ . Input AC drive levels are  $V_{IL} = 0.45V$  and  $V_{IH} = 2.4V$ .
- 2.  $\overline{OE}$  may be delayed up to  $t_{CE}$   $t_{OE}$  after the falling edge of  $\overline{CE}$  without impact on  $t_{CE}$ .
- 3.  $\overline{\text{OE}}$  may be delayed up to  $t_{\text{ACC}}$   $t_{\text{OE}}$  after the address is valid without impact on  $t_{\text{ACC}}$ .
- 4. This parameter is only sampled, and is not 100% tested.
- 5. Output float is defined as the point when data is no longer driven.

Figure 5-2. Input test waveforms and measurement levels

#### For -45 devices only:



#### For -70 devices:

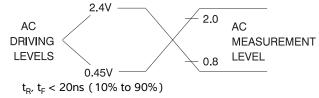
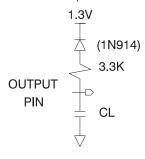






Figure 5-3. Output test load



Note: 1.  $C_L = 100 pF$  including jig capacitance, except for the -45 devices, where  $C_L = 30 pF$ .

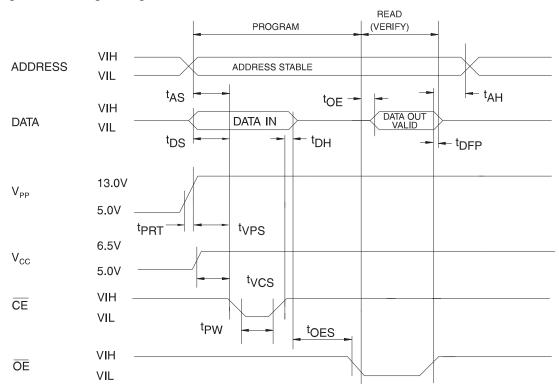
Table 5-5. Pin capacitance

 $f = 1MHz, T = 25°C^{(1)}$ 

Symbol	Тур	Max	Units	Conditions
C <sub>IN</sub>	4	6	pF	$V_{IN} = 0V$
C <sub>OUT</sub>	8	12	pF	V <sub>OUT</sub> = 0V

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled, and is not 100% tested.

Figure 5-4. Programming Waveforms<sup>(1)</sup>



Notes: 1. The input timing reference is 0.8V for  $\rm V_{IL}$  and 2.0V for  $\rm V_{IH}$ 

- 2.  $t_{\text{OE}}$  and  $t_{\text{DFP}}$  are characteristics of the device, but must be accommodated by the programmer.
- 3. When programming the Atmel AT27C256R, a  $0.1\mu F$  capacitor is required across  $V_{pp}$  and ground to suppress spurious voltage transients.

Table 5-6. DC programming characteristics

$$T_A = 25 \pm 5$$
°C,  $V_{CC} = 6.5 \pm 0.25$ V,  $V_{PP} = 13.0 \pm 0.25$ V

			Limits		
Symbol	Parameter	Test Conditions	Min	Max	Units
I <sub>LI</sub>	Input load current	$V_{IN} = V_{IL} V_{IH}$		±10	μA
V <sub>IL</sub>	Input low level		-0.6	0.8	V
V <sub>IH</sub>	Input high level		2.0	V <sub>CC</sub> + 1	V
V <sub>OL</sub>	Output low volt	$I_{OL} = 2.1 \text{mA}$		0.4	V
V <sub>OH</sub>	Output high volt	Ι <sub>ΟΗ</sub> = -400μΑ	2.4		V
I <sub>CC2</sub>	V <sub>CC</sub> supply current (program and verify)			25	mA
I <sub>PP2</sub>	V <sub>pp</sub> current	CE = V <sub>IL</sub>		25	mA
V <sub>ID</sub>	A9 product identification voltage		11.5	12.5	V

Table 5-7. AC programming characteristics

$$T_A = 25 \pm 5$$
 °C,  $V_{CC} = 6.5 \pm 0.25$ V,  $V_{PP} = 13.0 \pm 0.25$ V

			Lin		
Symbol	Parameter	Test conditions <sup>(1)</sup>	Min	Max	Units
t <sub>AS</sub>	Address setup time		2		μs
t <sub>OES</sub>	OE setup time	Input rise and fall times	2		μs
t <sub>DS</sub>	Data setup time	(10% to 90%) 20ns	2		μs
t <sub>AH</sub>	Address hold time	lanut aulaa lavala	0		μs
$t_{DH}$	Data hold time	Input pulse levels  0.45V to 2.4V	2		μs
t <sub>DFP</sub>	OE high to output float delay <sup>(2)</sup>		0	130	ns
t <sub>VPS</sub>	V <sub>pp</sub> setup time	Input timing reference level	2		μs
t <sub>VCS</sub>	V <sub>CC</sub> setup time	- 0.8V to 2.0V	2		μs
t <sub>PW</sub>	CE program pulse width <sup>(3)</sup>	Output timing reference level	95	105	μs
t <sub>OE</sub>	Data valid from $\overline{\text{OE}}^{(2)}$	0.8V to 2.0V		150	ns
t <sub>PRT</sub>	V <sub>pp</sub> pulse rise time during programming		50		ns

Notes: 1.  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$  and removed simultaneously with or after  $V_{PP}$ .

- 2. This parameter is only sampled, and is not 100% tested. Output float is defined as the point where data is no longer driven. See timing diagram.
- 3. Program pulse width tolerance is  $100\mu s \pm 5\%$ .

Table 5-8. The Atmel AT27C256R integrated product identification code

		Pins					Hex			
Codes	A0	07	O6	O5	04	О3	02	01	00	data
Manufacturer	0	0	0	0	1	1	1	1	0	1E
Device type	1	1	0	0	0	1	1	0	0	8C

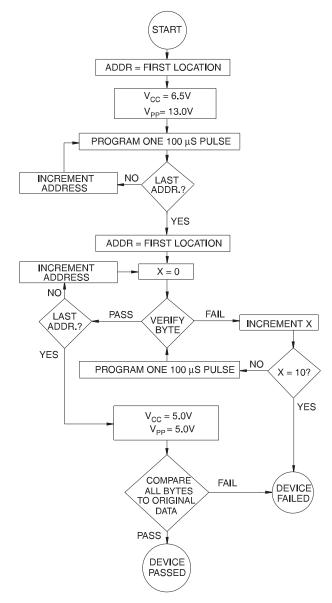




### 6. Rapid programming algorithm

A 100 $\mu$ s  $\overline{\text{CE}}$  pulse width is used to program. The address is set to the first location.  $V_{CC}$  is raised to 6.5V and  $V_{PP}$  is raised to 13.0V. Each address is first programmed with one 100 $\mu$ s  $\overline{\text{CE}}$  pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100 $\mu$ s pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked.  $V_{PP}$  is then lowered to 5.0V and  $V_{CC}$  to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.

Figure 6-1. Rapid programming algorithm



# 7. Ordering information

# Green package (Pb/halide-free)

t <sub>ACC</sub>	I <sub>CC</sub> (mA)					
(ns)	Active	Standby	Atmel ordering code	Package	Lead finish	Operation range
45	20	0.1	AT27C256R-45JU	32J	Matte tin	Industrial
45	20	0.1	AT27C256R-45PU	28P6	Matte tin	(-40°C to 85°C)
70	20	0.1	AT27C256R-70JU	32J	Matte tin	Industrial
/0	20 0.1		AT27C256R-70PU	28P6	Matte tin	(-40°C to 85°C)

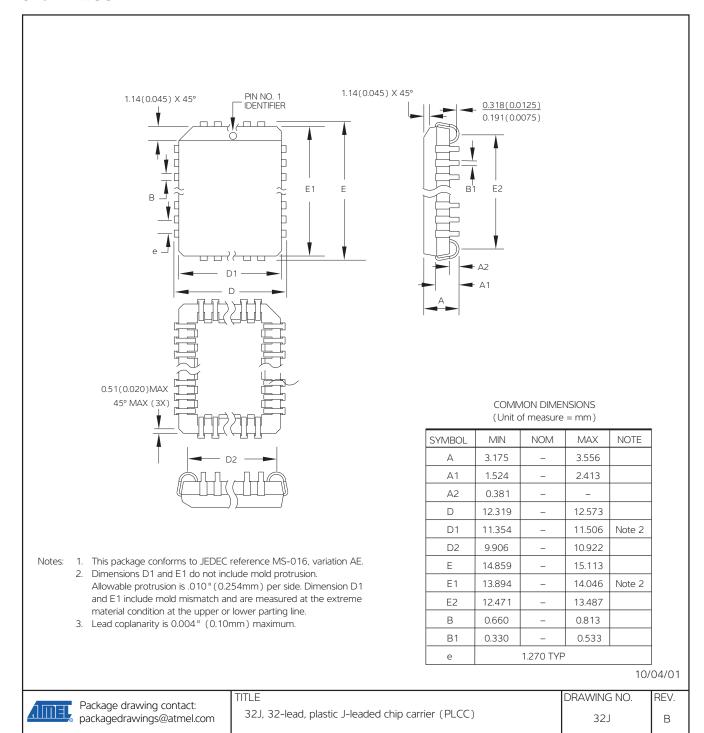
Package type			
32J	32-lead, plastic, J-leaded chip carrier (PLCC)		
28P6	28-lead, 0.600" wide, plastic, dual inline package (PDIP)		



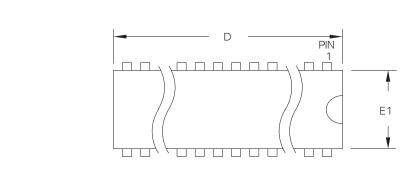


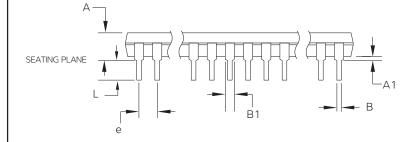
## 8. Packaging information

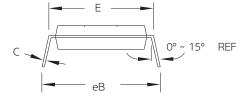
### 32J – PLCC



## 28P6 - PDIP







COMMON DIMENSIONS (Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
А	-	-	4.826	
A1	0.381	-	_	
D	36.703	_	37.338	Note 2
Е	15.240	-	15.875	
E1	13.462	-	13.970	Note 2
В	0.356	-	0.559	
B1	1.041	_	1.651	
L	3.048	-	3.556	
С	0.203	-	0.381	
eB	15.494	_	17.526	
е	2.540 TYP			

Notes: 1. This package conforms to JEDEC reference MS-011, variation AB

2. Dimensions D and E1 do not include mold flash or protrusion mold flash or protrusion shall not exceed 0.25mm (0.010")

09/28/01

Г		TITLE	DRAWING NO.	REV.
4	Package drawing contact: packagedrawings@atmel.com	28P6, 28-lead (0.600"/15.24mm wide) plastic dual inline package (PDIP)	28P6	В





# 9. Revision history

Doc. rev.	Date	Comments	
00140	10/2011	Correct pinouts	
0014N	04/2011	Remove TSOP and SOIC packages	
		Add lead finish to ordering information	
0014M	12/2007		



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